FDD5670

FAIRCHILD

60V N-Channel PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed. extremely low $R_{DS(ON)}$ in a small package.

Applications

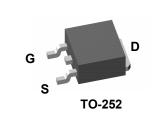
- DC/DC converter
- Motor drives

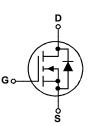
Features

- 52 A, 60 V $R_{DS(ON)}$ = 15 m Ω @ V_{GS} = 10 V $R_{DS(ON)}$ = 18 m Ω @ V_{GS} = 6 V
- Low gate charge
- Fast switching

.

- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		60	V
V _{GSS}	Gate-Source Voltage		±20	V
I _D	Drain Current – Continuous	(Note 3)	52	A
	– Pulsed	(Note 1a)	150	
PD	Power Dissipation for Single Operation	(Note 1)	83	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +175	°C
Therma	I Characteristics			
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	1.8	°C/W
$R_{ ext{ hetaJA}}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
R _{eja}	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity	
FDD5670	FDD5670 13"		16mm	2500 units	

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	burce Avalanche Ratings (Note	e 2)				
W _{DSS}	Drain-Source Avalanche Energy	Single Pulse, V_{DD} = 20 V, I_D = 10A			360	mJ
I _{AR}	Drain-Source Avalanche Current				10	А
Off Char	acteristics	•		•		
BV _{DSS}	Drain–Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	60			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		53		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
IGSSF	Gate-Body Leakage, Forward	$V_{GS} = 20 V$, $V_{DS} = 0 V$			100	nA
	Gate–Body Leakage, Reverse	$V_{GS} = -20 V$, $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2	2.5	4	V
<u>ΔVGS(th)</u> ΔTJ	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-6		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			12 14 19	15 18 26	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = 10 V$, $V_{DS} = 5 V$	60			А
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 10 A$		27		S
Dvnamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		2739		pF
Coss	Output Capacitance	f = 1.0 MHz		441		pF
C _{rss}	Reverse Transfer Capacitance			182		pF
Switchin	ng Characteristics (Note 2)	·				
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 30 V, \qquad I_D = 1 A,$		20	32	ns
tr	Turn–On Rise Time	$V_{GS} = 10 V$, $R_{GEN} = 6 \Omega$		12	24	ns
t _{d(off)}	Turn–Off Delay Time			60	95	ns
t _f	Turn–Off Fall Time			24	38	ns
Qg	Total Gate Charge	$V_{DS} = 15 V$, $I_{D} = 10 A$,		52	73	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		10		nC
Q _{gd}	Gate–Drain Charge			13		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source	e Diode Forward Current			3.5	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 3.5 A$ (Note 2)		0.74	1.2	V

Scale 1 : 1 on letter size paper

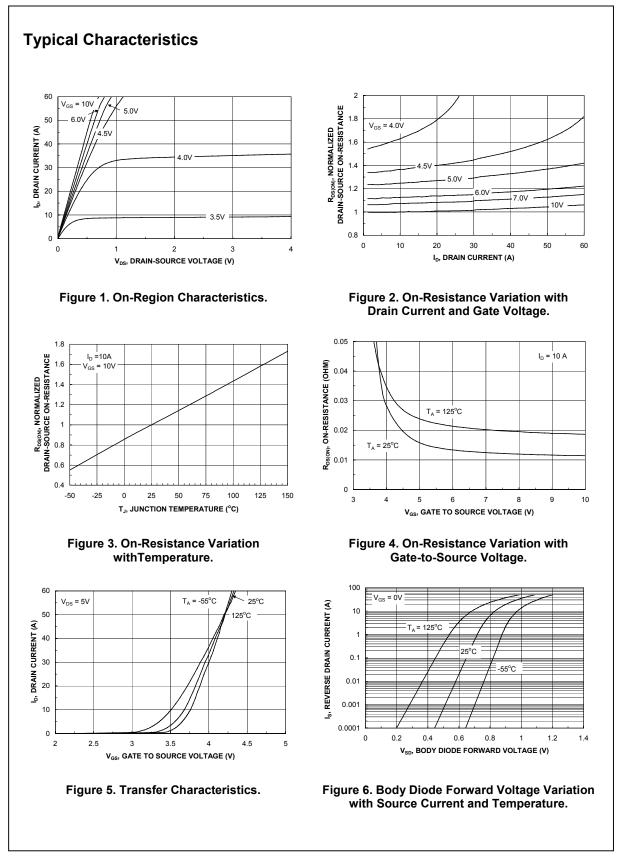
where P_D is maximum power dissipation at T_C = 25°C and $R_{DS(on)}$ is at $T_{J(max)}$ and V_{GS} = 10V. Package current limitation is 21A

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

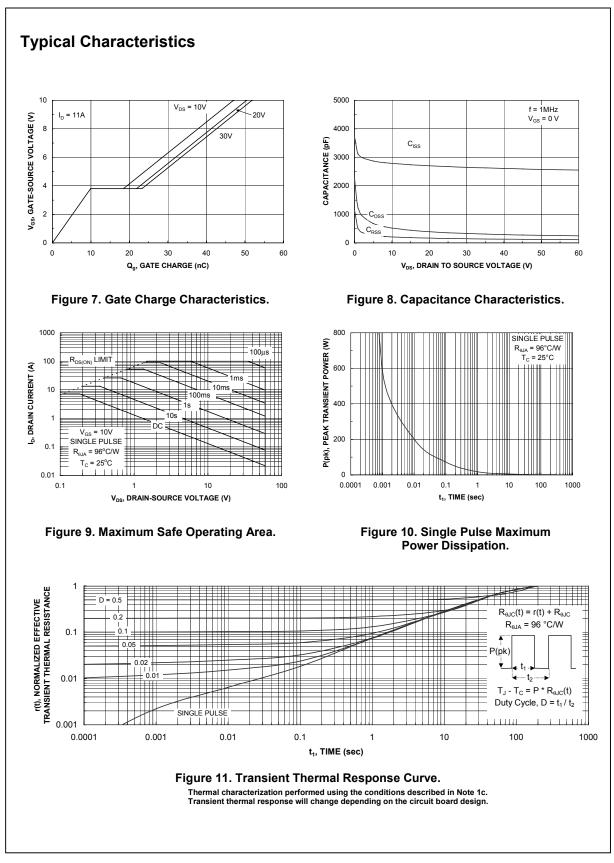
3. Maximum current is calculated as:

 $\sqrt{\frac{P_{D}}{R_{DS(ON)}}}$

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